

# AGD-312D

REV.A0.1

## Environment Test Report

Report NO: 11P020013

Summary	<p><input checked="" type="checkbox"/> <b>Pass</b></p> <p><input type="checkbox"/> <b>Fail</b></p> <p>Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> <b>Pass with Deviation</b></p> <p>Comment: _____</p>
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Issue date

Approval

Test Engineer

2011-06-27

Jansin Lee

Clement Chien

## Test item list

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### Testing Result

Num	Test item list	Result	Remark
1	Temperature rise test	Pass	
2	Temperature cycle operation test	Pass	
3	High temperature storage test	Pass	
4	Low temperature storage test	Pass	
5	Humidity test	Pass	
6	Cold start and hot start test	Pass	

# Configuration of EUT

## Host :

Item	Device Information	
SYSTEM PC Model / Ver.	AEC-6625 A0.2	
CPU Board	EPIC-QM57 A1.0	
BIOS / Version	AEC-6625 1.0(01/06/2011)	
CPU Type	Intel Celeron P4500 1.87GHz(133x14)	
Memory Type	DSL DDR3-1066 2GB(ELPIDA J1108BDSE-DJ-F)	
SATA HDD	TOSHIBA 2.5" 160GB(MK1665GSX)	
USB DVD-ROM	LITEON DX-20A4PU	
LCD Monitor	AGD-312D	
Operating System	<input checked="" type="checkbox"/>	Windows XP Professional English SP3 32 Bit
DC Adapter	DC Power Input 12V / 5A	
	Chipset Information with XP Professional English SP3 32 Bit Driver Version	
Chipset Software	Intel(R) Chipset Device Software: 9.1.1.1020(2009/08/26)	
North Bridge	N/A	
South Bridge	Intel QM57	
Super IO Chipset	ITE8781F	
VGA Chipset	Intel(R)GMA HD 6.14.10.5179(2009/11/9)	
Audio Chipset	VIA VT1708B 6.0.1.7300 (2009/07/10)	
Ethernet Chipset	Intel(R)82577LM Gigabit 11.2.19.0(2009/09/23) Intel(R)82574L Gigabit 11.1. 6.0(2009/07/13)	

Num	Item	Spec
1.	<b>System:</b>	AGD-312D
	1.A/D Board	ONYX S2523BVL Rev : 0V
	2. Panel	AUO 17" SXGA(1280*1024) TFT LCD Display
	3. Touch Board	EETI S5000CEGG Rev : V1.08D1
	4. Test Software	Windows XP / Run PassMark Burn In Test 6.0 Pro
2.	<b>Adapter :</b>	FSP060-DBAB1 AC-DC 12V / 5A

# Temperature rise test

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**Test Date:** 06-27-2011

**Test Product:** AGD-312D

**Test Site:** AAEON QE Internal Lab.

**Test Standard:** Reference EN 61131-2(94), UL508 (94)

**Temperature Measurement:**

40 Channel Thermal Recorder:

YOKOGAWA Inc,

Model: AGD-312D

Date of Calibration: 06/15/2011

Serial Number: 12A323190

**Test Condition:**

Ambient temperature: 60°C

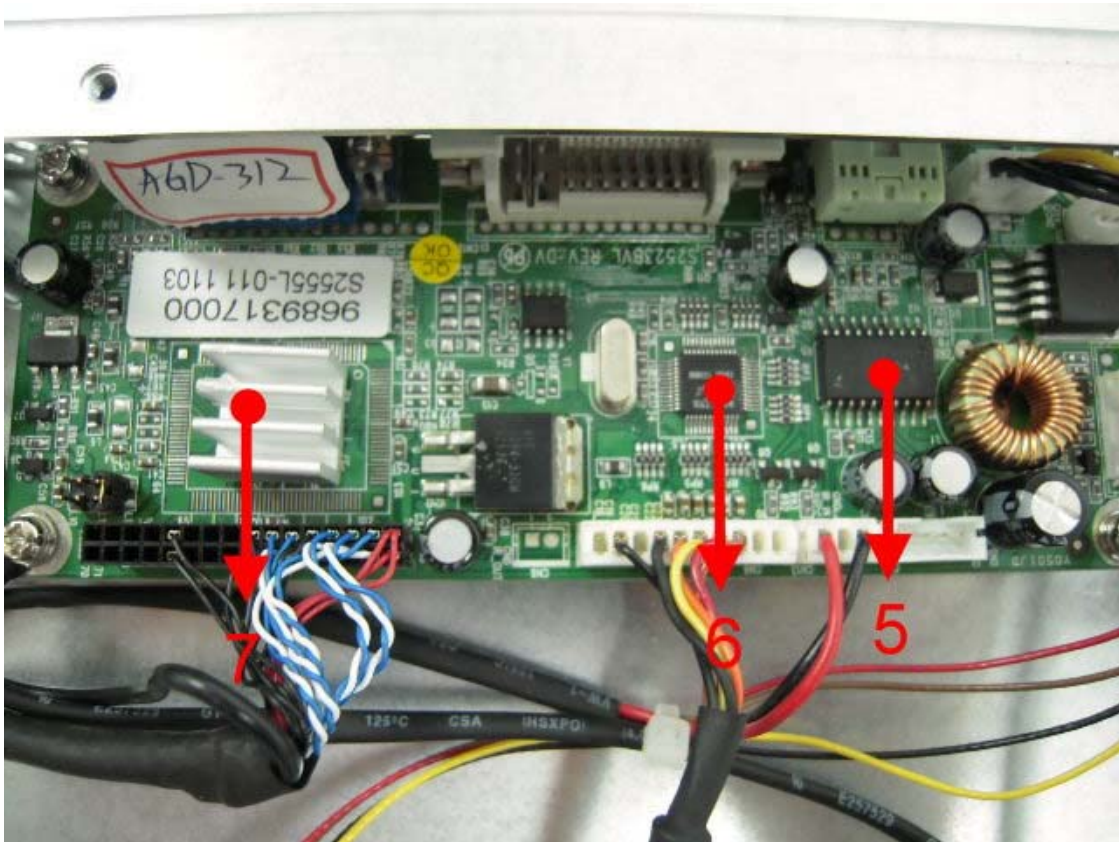
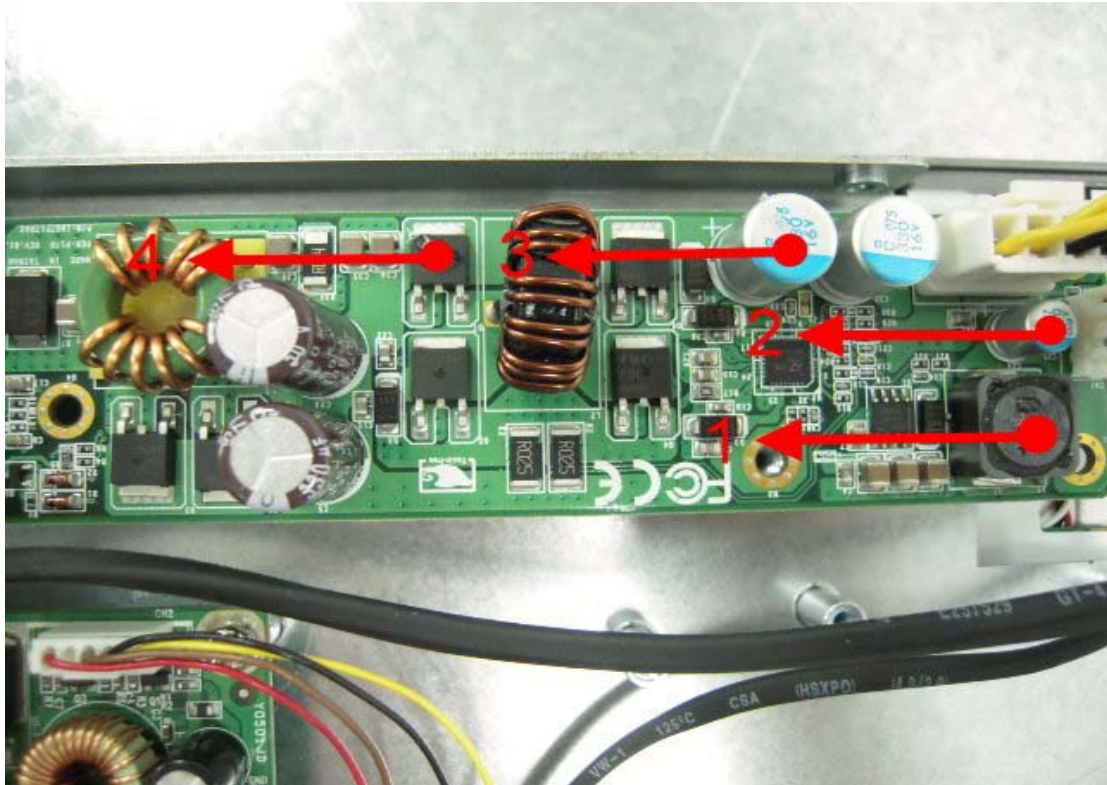
Continuous running till thermal stability (within less than 1°C)

**Test Software:**

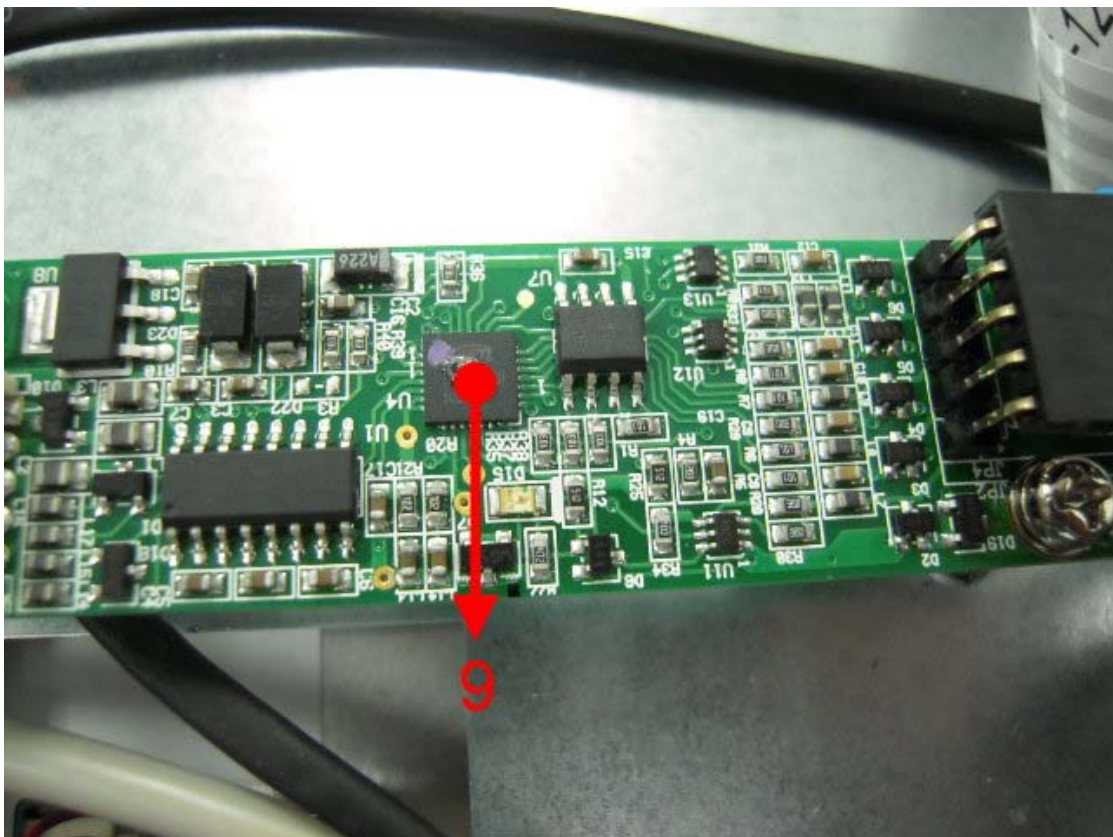
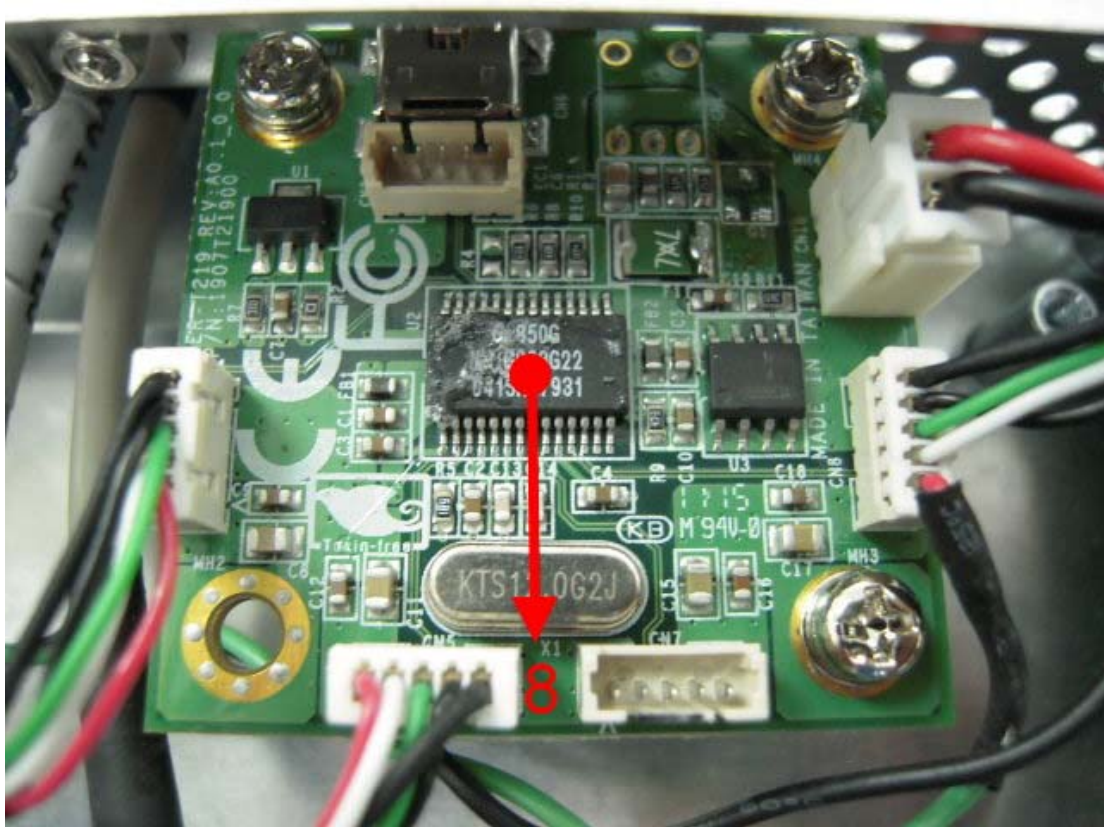
Windows XP / Run PassMark Burn In Test 6.0 Pro

**Terminal Recorder:**

# Temperature rise test



# Temperature rise test



# Temperature rise test

## Thermal profile data:

Point	Temp. Stage(°C)	Spec	60	25
<b>AGD-312D</b>				
01. L1 – 150mH		125	73.5	38.5
02. C24		125	72.8	37.8
03. C32		125	72.9	37.9
04. Q5 – 1A41AP FDD8896		130	72.3	37.3
05. U6 - REALTEK RTD2555LH		85	80.9	45.9
06. U5 - AIC 1084-33GM		115	114.9	79.9
07. U4 - REALTEK RTD2120L A6M2002		85	82.3	47.3
08. U2 - GL850G HH1GD08G22		85	75.6	40.6
09. U4 – EETI S458XRUP		85	72.8	37.8
10. Control Box Inside Air Temperature		N/A	72.7	37.7
11. Control Box Surface Temperature		N/A	67.6	32.6
12. Chamber Air Temperature		N/A	60.2	25.2
<b>Any Tm value showed in red words which meaning the value over the Tc degree C of this device specification.</b>				

## Sample Configuration & Quantity Under Test:

Quantity: 1 (AGD-312D)

## Test Result:

No problem was found during the temperature rise operation test.

# Temperature cycle test

**Test Date:** 06-24 ~ 26-2011

**Test Product:** AGD-312D

**Test Site:** AAEON QE Internal Lab.

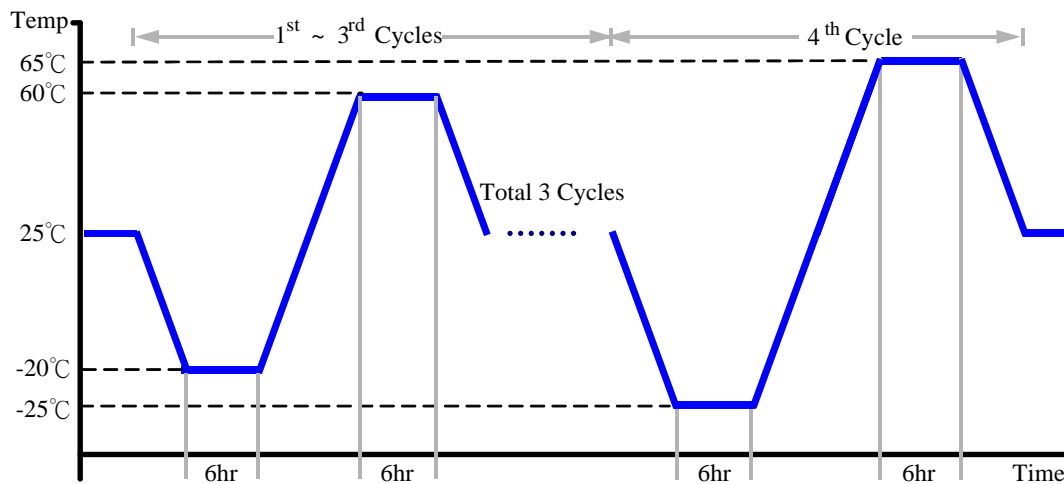
**Test Standard:** Reference IEC68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**

Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.  
Model: THS-D75-100+LN2  
Date of Calibration: 12/02/10  
Serial Number: 6487KT

**Test Condition:**

1. Test Low Temperature: -20°C (1~3 cycles)  
-25°C (4<sup>th</sup> cycle)
2. Test High Temperature: 60°C (1~3 cycles)  
65°C (4<sup>th</sup> cycle)
3. Test dwell time: 6Hrs
4. Temperature slope: 2°C/min
5. Test cycle: 4 cycles
6. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (AGD-312D)

**Test Result:**

No problem was found during the temperature operation cycle test.



# High temperature storage test

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**Test Date:** 06-16 ~ 18-2011

**Test Product:** AGD-312D

**Test Site:** AAEON QE Internal Lab.

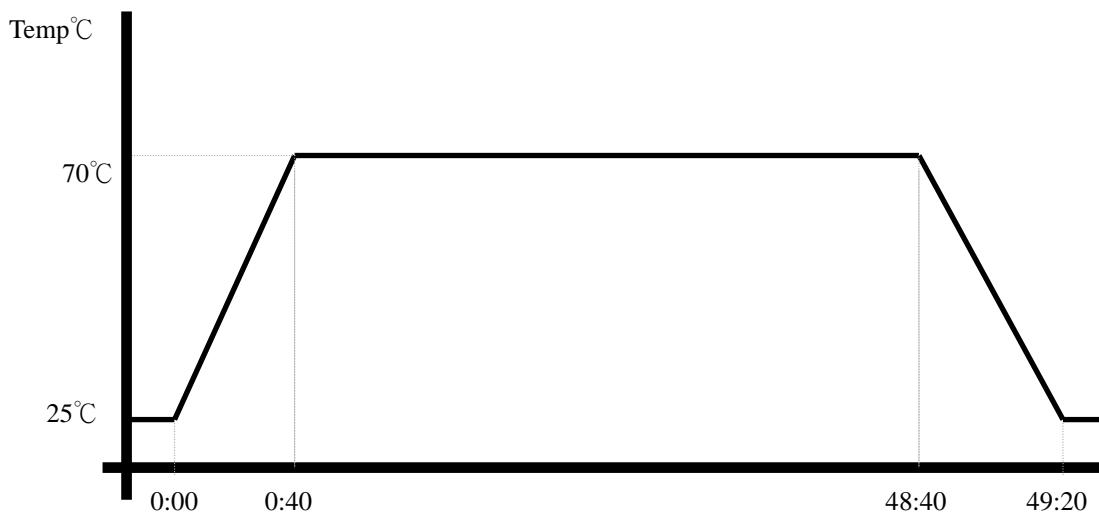
**Test Standard:** Reference IEC 68-2-2 Testing procedures  
Test Bb: Dry Heat Test (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.  
Model: THS-D75-100+LN2  
Date of Calibration: 12/02/10  
Serial Number: 6487KT

**Testing Item:**

1. Test Temperature: 70°C
2. Test Times: 48Hrs
3. Test Software: Windows XP / Run PassMark Burn In Test 6.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (AGD-312D)

**Test Result:**

No problem was found after the high temperature storage test.

# Low temperature storage test

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**Test Date:** 06-18 ~ 20-2011

**Test Product:** AGD-312D

**Test Site:** AAEON QE Internal Lab.

**Test Standard:** Reference IEC 68-2-1 Testing procedures  
Test Ab: Cold Test (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.

Model: THS-D75-100+LN2

Date of Calibration: 12/02/10

Serial Number: 6487KT

**Testing Item:**

1. Test Temperature: -20°C
2. Test Times: 48Hrs
3. Test Software: Windows XP / Run PassMark Burn In Test 6.0 Pro
4. Test Environment Curve:



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (AGD-312D)

**Test Result:**

No problem was found after the low temperature storage test.

# Humidity test

**Test Date:** 06-20 ~ 22-2011

**Test Product:** AGD-312D

**Test Site:** AAEON QE Internal Lab.

**Test Standard:** Reference IEC 68-2-3 Testing procedures  
Test Ca: Damp heat, steady state (Non-operation)

**Test Equipment:**

Programmable Temperature & Humidity Chamber

K.SON. INS. TECH. CORP.

Model: THS-D75-100+LN2

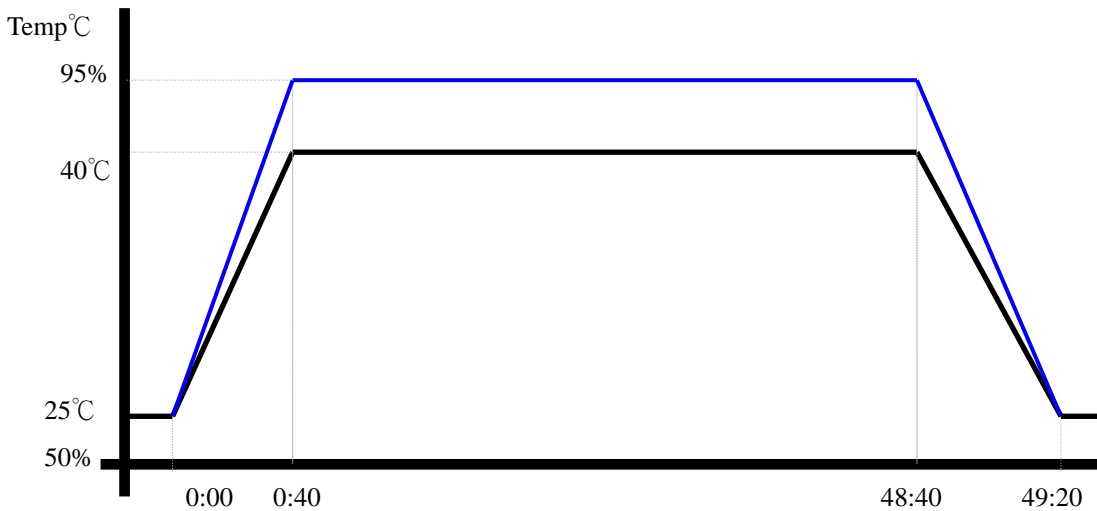
Date of Calibration: 12/02/10

Serial Number: 6487KT

**Testing Item:**

1. Test Temperature: 40°C
2. Test Humidity: 95%RH
3. Test Times: 48Hrs
4. Test Software: Windows XP / Run PassMark Burn In Test 6.0 Pro
5. Test Environment Curve:

**Humidity %**



**Sample Configuration & Quantity Under Test:**

Quantity: 1 (AGD-312D)

**Test Result:**

No problem was found after the humidity storage test.

# Cold start and hot start test

**Test Date:** 06-23 ~ 24-2011

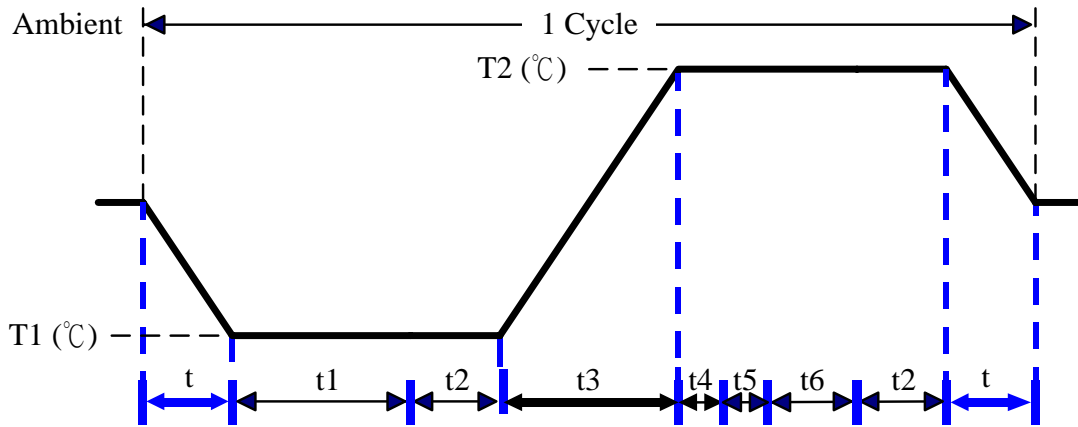
**Test Product:** AGD-312D

**Test Site:** AAEON QE Internal Lab.

**Test Standard:** Reference IEC 68-2-14 Testing procedures  
Test N: Change of temperature Test

**Test Equipment:**  
Programmable Temperature & Humidity Chamber  
K.SON. INS. TECH. CORP.  
Model: THS-D75-100+LN2  
Date of Calibration: 12/02/10  
Serial Number: 6487KT

**Test Condition:**



Parameters	Description
T1	-25°C
T2	65°C
t1	4 hrs
t2, t6	2 hrs
t4, t5	1hrs
t, t3	2°C/min
n (Cycle)	1

t = temperature slope  
t, t1, t6: Power Off  
t2: Power on/off test 10 times (on 2 min / off 5min)  
t3, t4: Run PassMark Burn In Test  
t5: Win XP Software restart test 3 times  
Test Software: Windows XP

**Test Result:**

- a. No problem was found during the cold start test.
- b. No problem was found during the hot start test.